





SURFACE MOUNT LOW LEAKAGE DIODE

Features

- Ultra Low Leakage Current (5nA @ V_R = 75V)
- Low Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Bar
- Terminals: Finish Matte Tin Finish Annealed over Alloy 42
 Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.004 grams (Approximate)

SOD323



Top View

Ordering Information (Note 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
BAV116WSQ-7	Automotive	TW	7	8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SOD323



TW = Product Type Marking Code Bar Denotes Cathode Side



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _R WM V _R	85	V
RMS Reverse Voltage	V _{R(RMS)}	60	V	
Forward Continuous Current (Note 6)		I _{FM}	215	mA
Repetitive Peak Forward Current		I _{FRM}	500	mA
@ t = 1.0μs Non-Repetitive Peak Forward Surge Current @ t = 1.0ms @ t = 1.0s		I _{FSM}	4.0 1.0 0.5	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

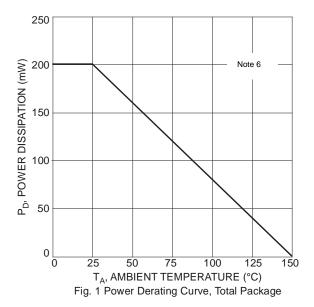
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	85	_	_	٧	$I_R = 100\mu A$
Forward Voltage	V _F	_	_	0.9 1.0 1.1 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Leakage Current (Note 7)	I _R	_	_	5.0 80		V _R = 75V V _R = 75V, T _J = +150°C
Total Capacitance	C _T	_	1.5	_	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	_	3.0	μs	$\begin{split} I_F &= I_R = 10 \text{mA}, \\ I_{rr} &= 0.1 \times I_R, \ R_L = 100 \Omega \end{split}$

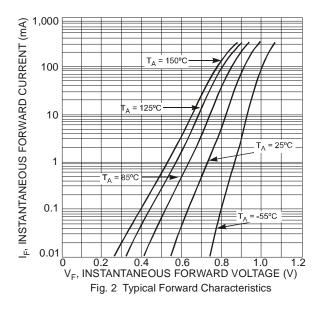
Notes:

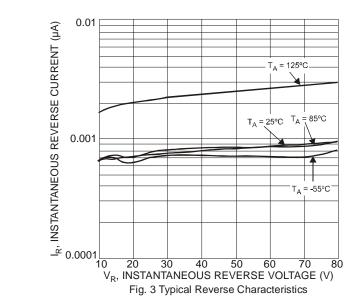
^{6.} Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.

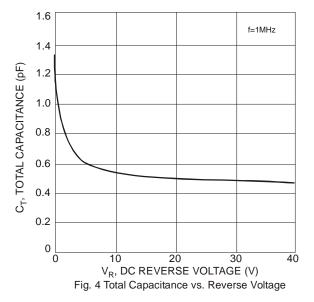
^{7.} Short duration pulse test used to minimize self-heating effect.







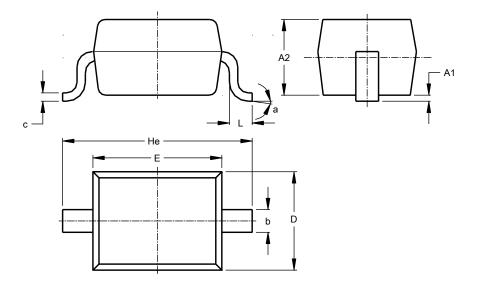






Package Outline Dimensions

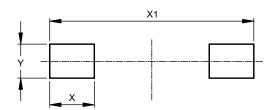
Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



SOD323					
Dim	Min	Max	Тур		
A1		0.10	0.05		
A2	1.00	1.10	1.05		
b	0.25	0.35	0.30		
С	0.10	0.15	0.11		
D	1.20	1.40	1.30		
Е	1.60	1.80	1.70		
He	2.30	2.70	2.50		
L	0.20	0.40	0.30		
а	00	8º			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.590
X1	2.700
Y	0.450



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